

1.8V 1A Positive Voltage Regulator

Features

- Output current in excess of 1A
- Output voltage accuracy +2.5%/-2%
- Quiescent current typically 480 μ A
- Internal short-circuit current-limit
- Internal over-temperature protection

Applications

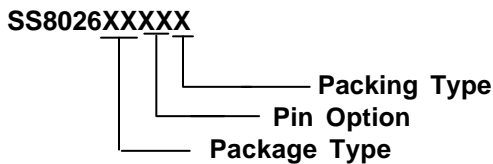
- PC motherboard
- ADSL/Cable Modem
- Set-Top Box
- LAN switch/Hub
- Broadband/Router

General Description

The SS8026 positive 1.8V voltage regulator features the ability to source 1A of output current. The typical quiescent current is 0.48mA.

Familiar regulator features such as over-temperature and over-current protection circuits are provided to prevent it from being damaged by abnormal operating conditions.

Ordering Information



PACKAGE TYPE

- T2 : SOT-89
- T3 : TO 220
- T4 : TO 252
- T5 : TO-263
- T6 : SOT-223

PIN OPTION

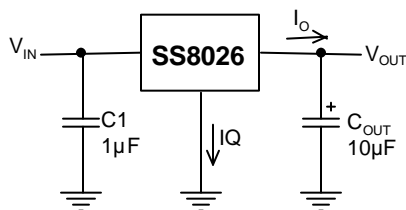
	1	2	3
1 :	V_{OUT}	GND	V_{IN}
2 :	V_{OUT}	V_{IN}	GND
3 :	GND	V_{OUT}	V_{IN}
4 :	GND	V_{IN}	V_{OUT}
5 :	V_{IN}	GND	V_{OUT}
6 :	V_{IN}	V_{OUT}	GND

PACKING

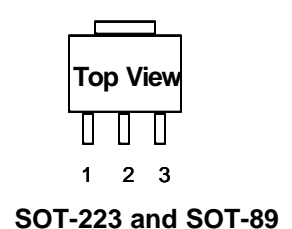
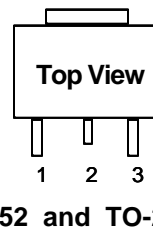
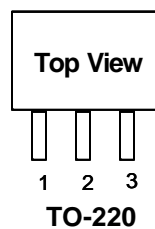
- TR : Tape & Reel
- TB : Tubes

Typical Application

[Note 4] : Type of C_{OUT}



Pin Configuration



Absolute Maximum Ratings (Note 1)

Input Voltage.....	7V
Power Dissipation Internally Limited.....	(Note 2)
Maximum Junction Temperature.....	150°C
Storage Temperature Rang.....	-65°C ≤ T _J ≤ +150°C
Lead Temperature, Time for Wave Soldering	
SOT 223 Package.....	260°C, 4s
Continuous Power Dissipation (T _A = +25°C)	
SOT 89 ⁽¹⁾	0.5W
SOT 223 ⁽¹⁾	0.8W
TO 252 ⁽¹⁾	1.0W

 Note ⁽¹⁾: See Recommended Minimum Footprint

Operating Conditions (Note 1)

Input Voltage.....	2.7V~6.5V
Temperature Range.....	0°C ≤ T _J ≤ 125°C

Electrical Characteristics
V_{IN} = 3.3V, I_O = 1A, C_{IN} = 1μF, C_{OUT} = 10μF, All specifications apply for T_A = T_J = 25°C. [Note 3]

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Output Voltage	10mA ≤ I _O ≤ 1A		1.764	1.800	1.845	V
Line Regulation	3V ≤ V _{IN} ≤ 6.5V, I _O = 10mA			3	30	mV
Load Regulation	10mA ≤ I _O ≤ 1A			30	50	mV
Output Impedance	200mA DC and 100mA AC, f _o = 120Hz			80		mΩ
Quiescent Current	V _{IN} = 3.3V			480		μA
Ripple Rejection	f _i = 120Hz, V _{ripple} = 1V _{P-P} , I _O = 100mA			53		dB
Dropout Voltage	I _O = 0A			880		mV
	I _O = 100mA			895		
	I _O = 500mA			950		
	I _O = 1A			1160		
Output Current	Continuous Test, T _A = 25°C, T _J 150°C, V _{OUT} within ±2%	V _{IN} = 3V (SOT 223)	Minimum footprint (0.0625 square inch)	660		mA
		V _{IN} = 3.3V (SOT 223)	Mounted on 0.53 square inch pcb area	1		A
		V _{IN} = 3.3V (SOT 89)	Mounted on 0.16 square inch pcb area	0.5		A
Short Circuit Current				1.6		A
Over Temperature				150		°C

Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Conditions are conditions under which the device functions but the specifications might not be guaranteed. For guaranteed specifications and test conditions see the Electrical Characteristics.

Note 2: The maximum power dissipation is a function of the maximum junction temperature, T_{Jmax}, total thermal resistance, θ_{JA}, and ambient temperature T_A. The maximum allowable power dissipation at any ambient temperature is T_{Jmax} - T_A / θ_{JA}. If this dissipation is exceeded, the die temperature will rise above 150°C and the IC will go into thermal shutdown. For the SS8026 in SOT 89 package, θ_{JA} is 250°C/W. For the SS8026 in SOT 223 package, θ_{JA} is 156°C/W; in TO 252 package, θ_{JA} is 125°C/W. (See recommend minimum footprint). The safe operation in SOT 89, SOT 223, TO 252 package, can be seen in "Typical Performance Characteristics" (Safe Operating Area).

Note3: Low duty pulse techniques are used during test to maintain junction temperatures as close to ambient as possible.

Note4: The output capacitor should be a tantalum or aluminum type.

Definitions

Dropout Voltage

The input/output voltage differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 100mV below its nominal value. Dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

Load Regulation

The change in output voltage for a change in load current at constant chip temperature. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

Maximum Power Dissipation

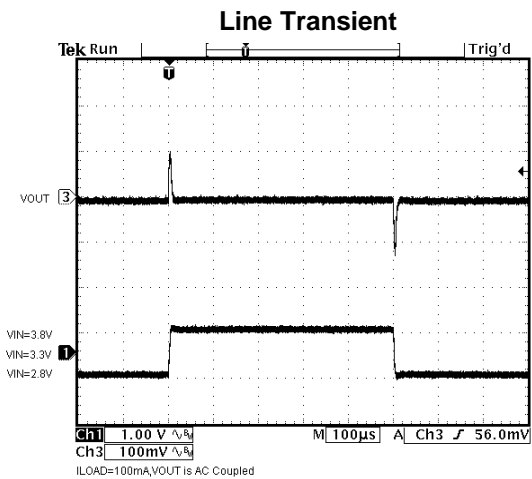
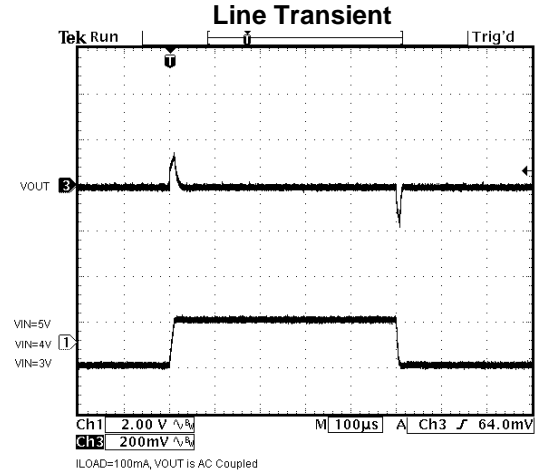
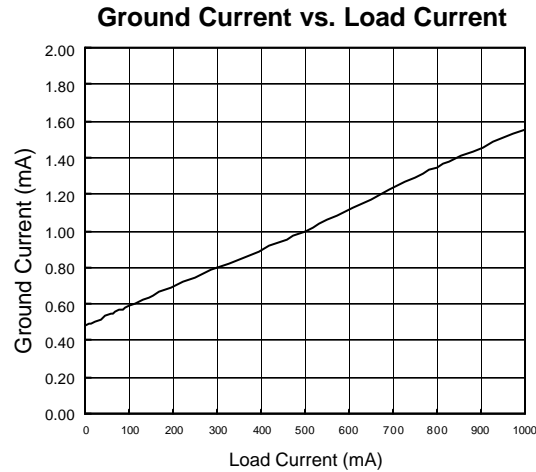
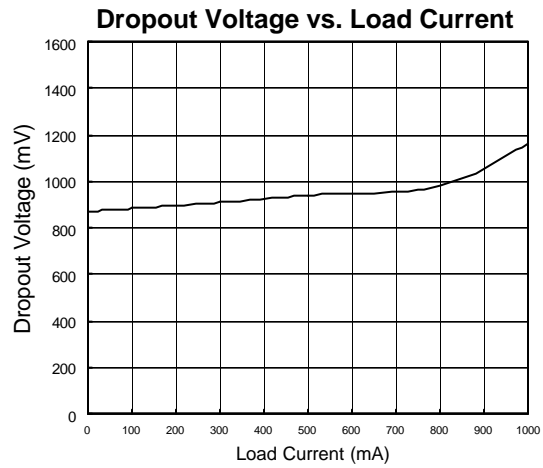
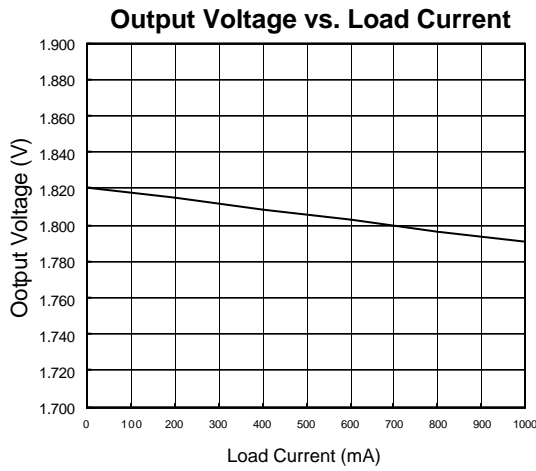
The maximum total device dissipation under which the regulator will operate within specifications.

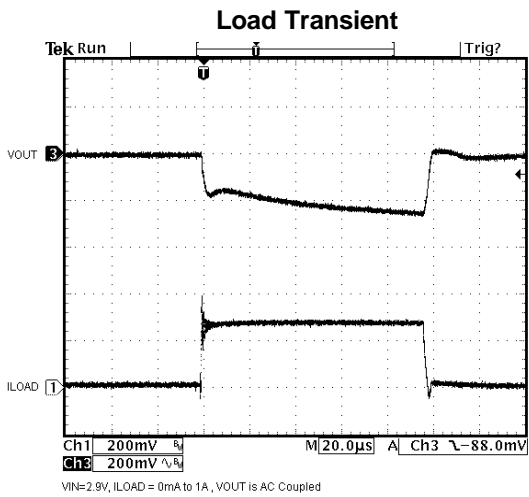
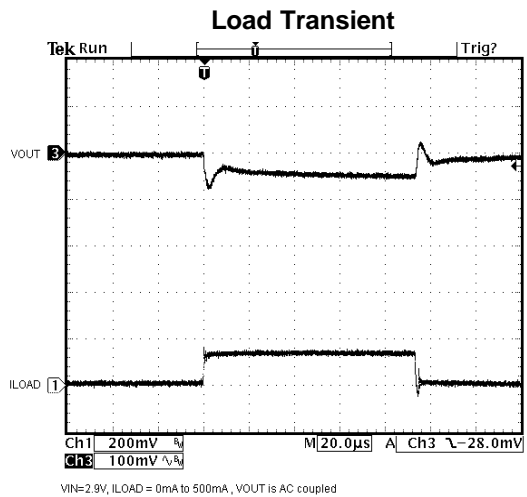
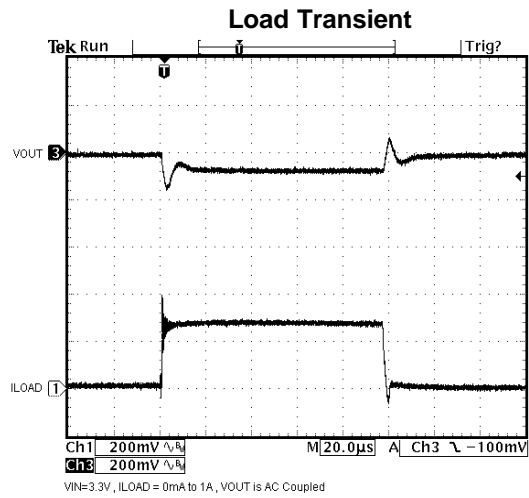
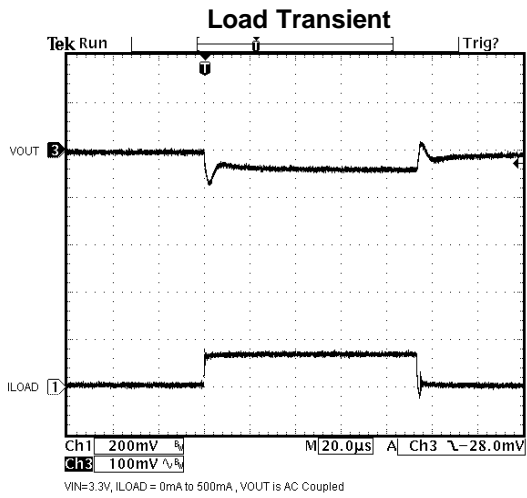
Quiescent Bias Current

Current which is used to operate the regulator chip and is not delivered to the load.

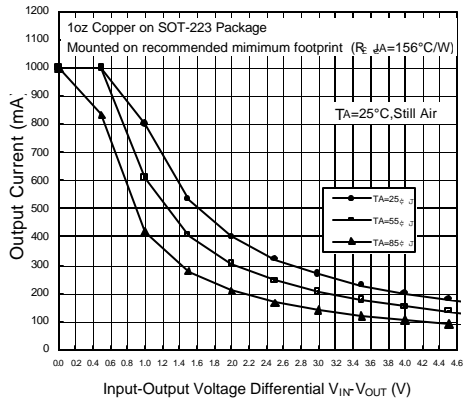
Typical Performance Characteristics

($V_{IN} = +3.3V$, $C_{IN} = 1\mu F$, $C_{OUT} = 10\mu F$, $T_A = 25^\circ C$, unless otherwise noted.)



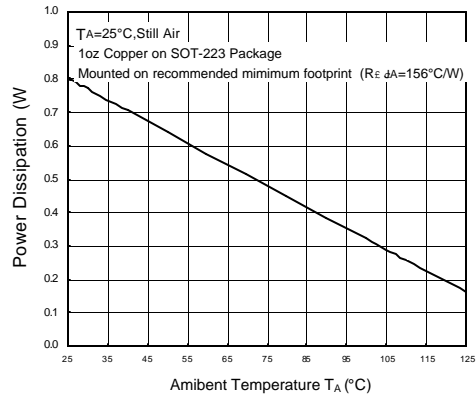
Typical Performance Characteristics (continued)


Safe Operating Area of SOT 223

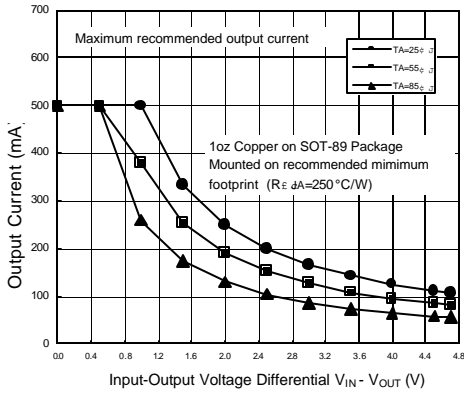


Note: $V_{IN(max)} \leq 6.5\text{V}$

Maximum Power Dissipation of SOT 223

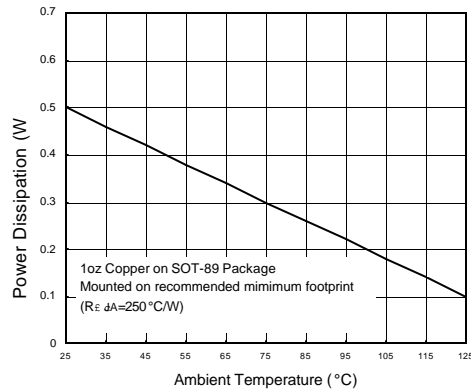


**Safe Operating Area of SOT-89
[Power Dissipation Limit]**

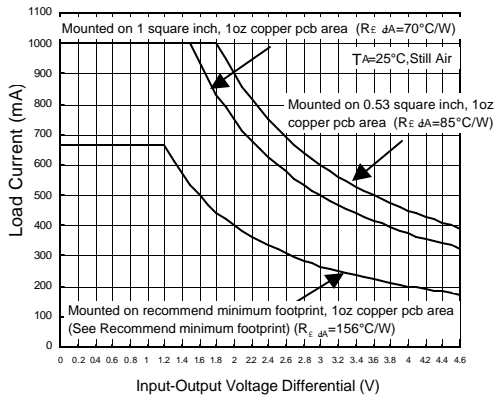


Note: $V_{IN(max)} \leq 6.5\text{V}$

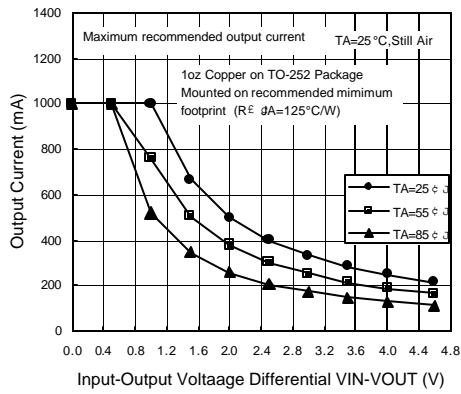
Maximum Power Dissipation of SOT-89



Safe Operating Area of SOT 223

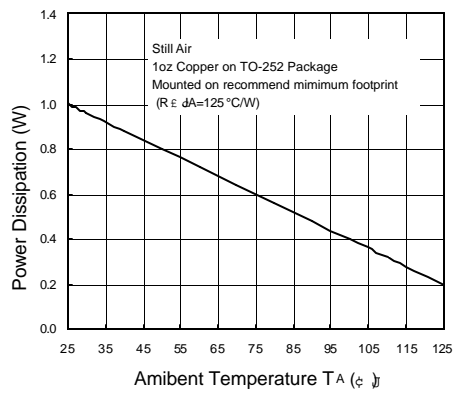


Safe Operating Area of TO 252

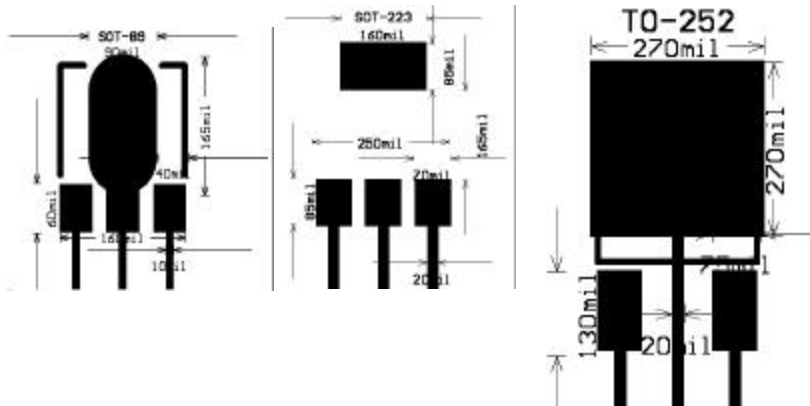


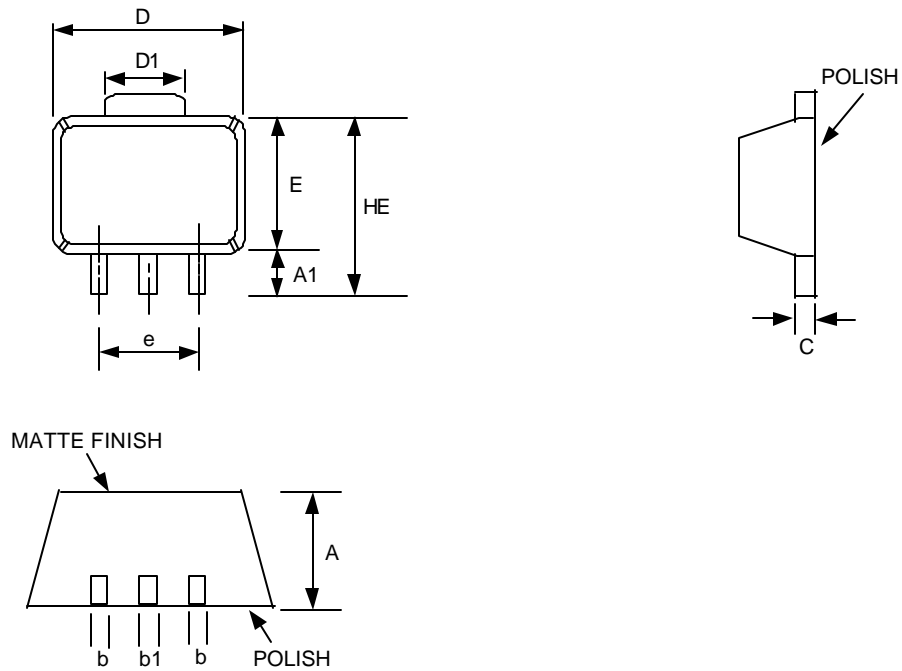
Note: V_{IN(max)} <= 6.5V

Maximum Power Dissipation of TO 252

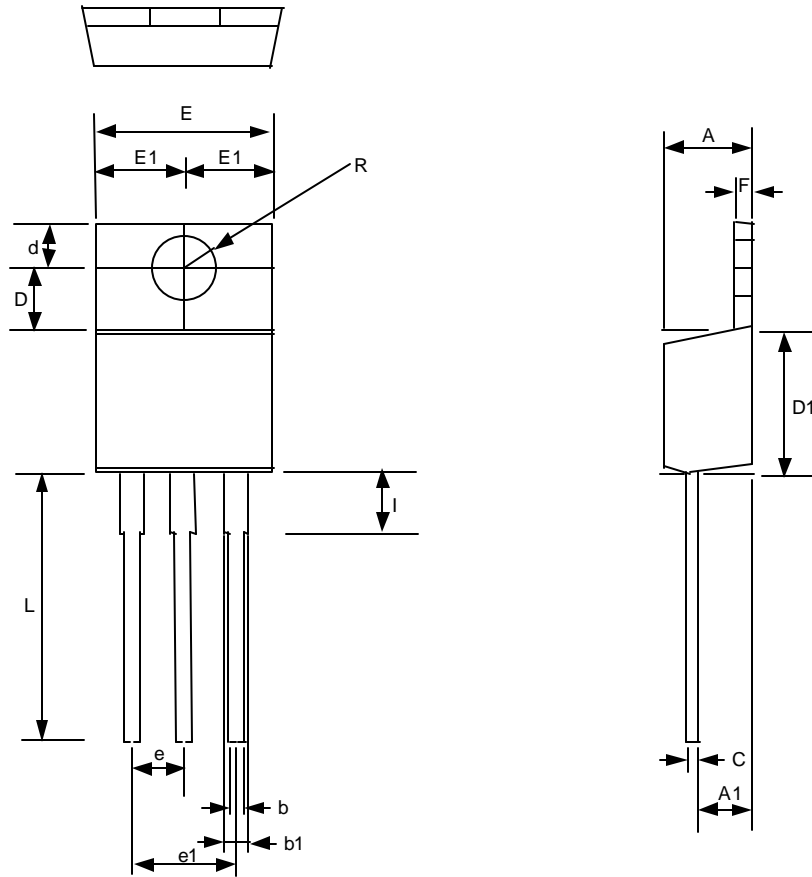


Recommend Minimum Footprint

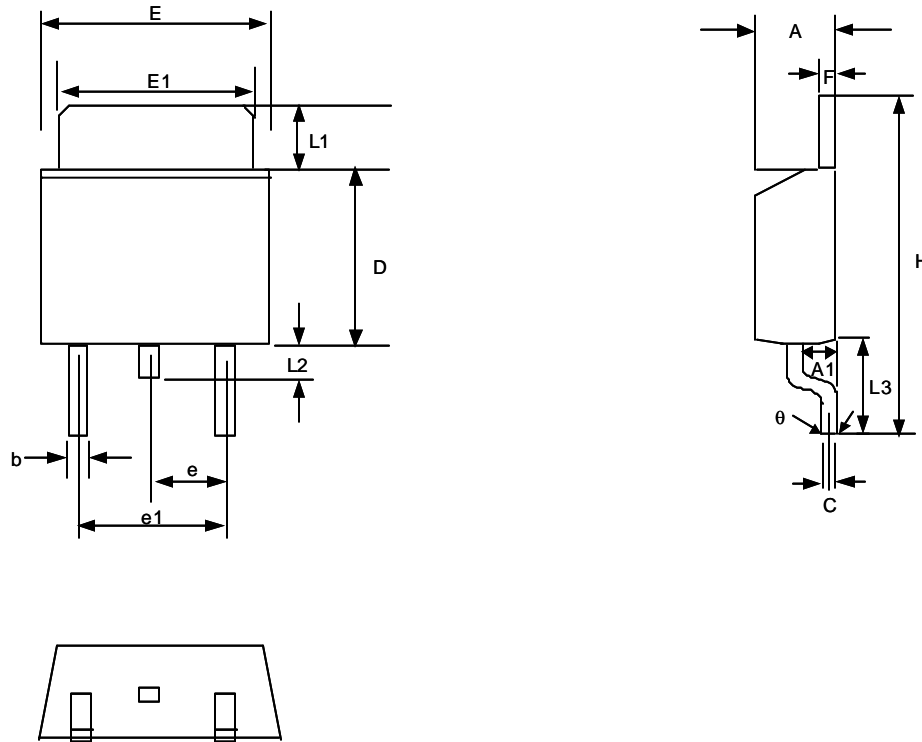


Package Information

SOT-89 (T2) Package

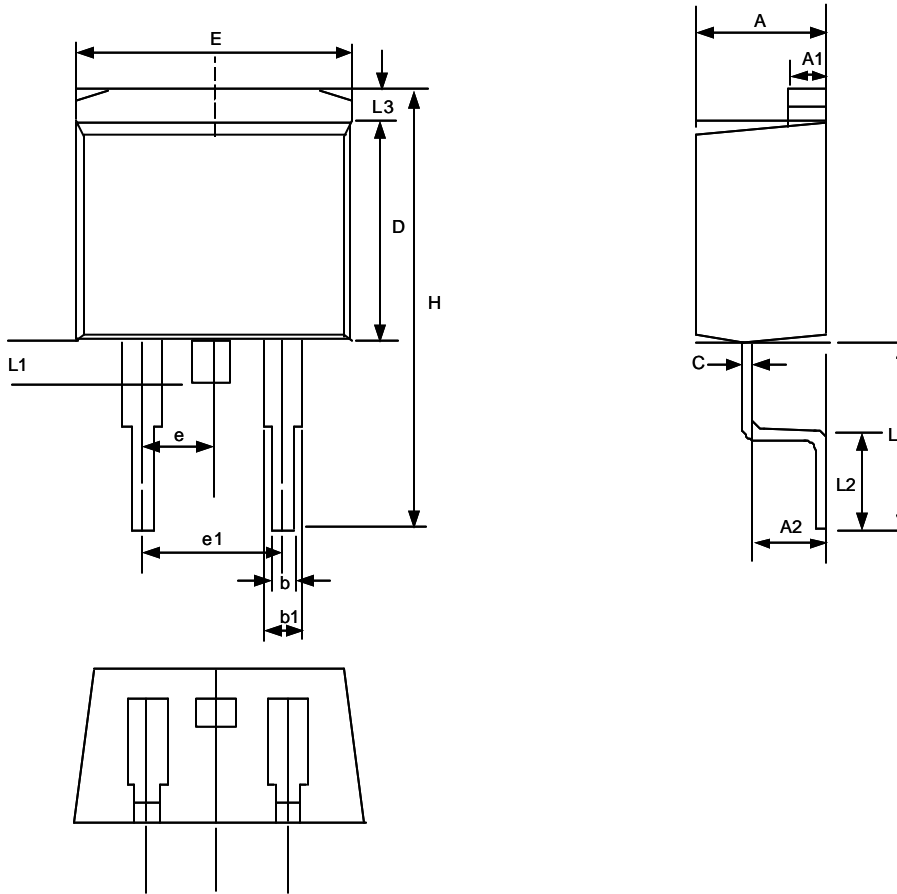
SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.40	1.50	1.60	0.055	0.059	0.063
A1	0.80	1.04	-----	0.031	0.041	-----
b	0.36	0.42	0.48	0.014	0.016	0.048
b1	0.41	0.47	0.53	0.016	0.018	0.020
C	038	0.40	0.43	0.014	0.015	0.017
D	4.40	4.50	4.60	0.173	0.177	0.181
D1	1.40	1.60	1.75	0.055	0.062	0.069
HE	-----	-----	4.25	-----	-----	0.167
E	2.40	2.50	2.60	0.094	0.098	0.102
e	2.90	3.00	3.10	0.114	0.118	0.122


TO-220 (T3) Package

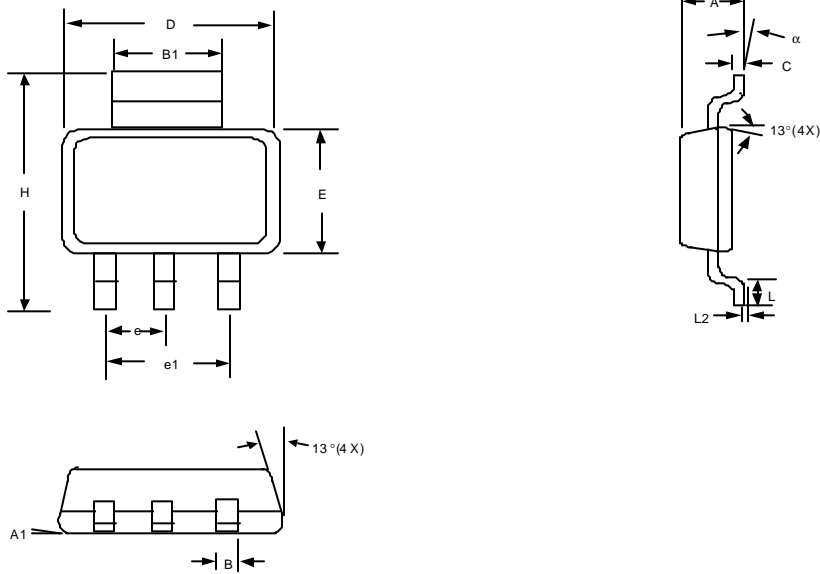
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.318	4.826	0.170	0.190
A1	2.46	2.72	0.097	0.107
b	0.69	0.94	0.027	0.037
b1	1.143	1.397	0.045	0.055
C	0.304	0.460	0.012	0.018
D	3.429	3.683	0.135	0.145
D1	8.53	9.04	0.336	0.356
d	2.62	2.87	0.103	0.113
E	9.906	10.40	0.390	0.410
E1	2.84	5.13	0.112	0.202
e	2.29	2.79	0.090	0.110
e1	4.83	5.33	0.190	0.210
F	1.143	1.397	0.045	0.055
I	3.454	3.962	0.136	0.156
L	13.589	14.351	0.535	0.565


TO-252 (T4) Package

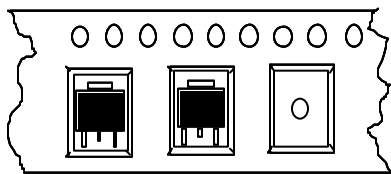
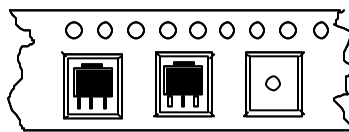
SYMBOL	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.19	2.38	0.086	0.094
A1	0.89	1.27	0.035	0.050
b	0.64	0.89	0.025	0.035
C	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
E	6.35	6.73	0.250	0.265
E1	5.21	5.46	0.205	0.215
e	2.26BSC		0.09BSC	
e1	3.96	5.18	0.156	0.204
F	0.46	0.58	0.018	0.023
L1	0.89	2.03	0.035	0.080
L2	0.64	1.02	0.025	0.040
L3	2.40	2.80	0.095	0.110
H	9.40	10.40	0.370	0.410
θ	0°	4°	0°	4°


TO-263 (T5) Package

SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.70	0.169	0.185
A1	1.22	1.32	0.048	0.055
A2	2.45	2.69	0.104	0.106
b	0.69	0.94	0.027	0.037
b1	1.22	1.40	0.048	0.055
C	0.36	0.56	0.014	0.022
D	8.64	9.652	0.340	0.380
E	9.70	10.54	0.382	0.415
e	2.29	2.79	0.090	0.110
e1	4.83	5.33	0.190	0.210
H	14.60	15.78	0.575	0.625
L	4.70	5.84	0.185	0.230
L1	1.20	1.778	0.047	0.070
L2	2.24	2.84	0.088	0.111
L3	1.40MAX		0.055MAX	


SOT-223 (T6) Package

SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.55	1.80	0.061	0.071
A1	0.02	0.12	0.0008	0.0047
B	0.60	0.80	0.024	0.031
B1	2.90	3.10	0.114	0.122
C	0.24	0.32	0.009	0.013
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
e	2.30 BSC		0.090 BSC	
e1	4.60 BSC		0.181 BSC	
H	6.70	7.30	0.264	0.287
L	0.90 MIN		0.036 MIN	
L2	0.06 BSC		0.0024 BSC	
a	0°	10°	0°	10°

Package Orientation on tape

Feed Direction
TO-252, TO-263 Package Orientation

Feed Direction
SOT 89, SOT-223 Package Orientation

Information furnished by Silicon Standard Corporation is believed to be accurate and reliable. However, Silicon Standard Corporation makes no guarantee or warranty, express or implied, as to the reliability, accuracy, timeliness or completeness of such information and assumes no responsibility for its use, or for infringement of any patent or other intellectual property rights of third parties that may result from its use. Silicon Standard reserves the right to make changes as it deems necessary to any products described herein for any reason, including without limitation enhancement in reliability, functionality or design. No license is granted, whether expressly or by implication, in relation to the use of any products described herein or to the use of any information provided herein, under any patent or other intellectual property rights of Silicon Standard Corporation or any third parties.